# THE DEPENDENCE OF BRIGHTNESS AND THRESHOLD VOLTAGE OF MEMORY ZnS:Mn THIN FILM ELECTROLUMINESCENT DEVICE UPON ITS THICKNESS 

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#### Abstract

Thin film electroluminescent devices made from $\mathrm{ZnS}: \mathrm{Mn}$ can be designed to exhibit an inherent hysteresis in the luminance vs. applied voltage characteristics. This memory behavior offers attractive advantages for efficient operation of displays with very large information content. Additionally, such memory devices can also be switched by light or electron beams, making possible such applications as image storage and a CRT with an active faceplate. If the device is driven near the threshold voltage, a pronounced hysteresis effect in the brightness vs. pulse width response curve also occurs. The dependence of brightness characteristics, as well as the threshold voltage and response time on the film thickness of the $\mathrm{ZnS}: \mathrm{Mn}$ layer is reported. The experimental results are in good agreement with the theoretical prediction.


## 1 INTRODUCTION

AC thin film electroluminescent (ACTFEL) devices based on ZnS doped with Mn active material, are now enjoying a growing interest since this technology has opened the way to design large-area, flat-screen displays [1]. Much effort is now spent on scaling up of the panel area, and higher resolution in display technologies. This is motivated by the growing demand for various portable terminals.

Memory ACTFEL devices show hysteresis in their brightness-voltage (B-V) response curve [2]. The hysteresis voltage margin, $\Delta V$, and saturation brightness $B_{\mathrm{s}}$, can be considered as the figures of merit for memory ACTFEL displays. In operating a memory ACTFEL device, we usually apply a sustaining AC voltage, $V_{\text {s }}$ (root-mean-square value), which is normally adjusted so as to be in the vicinity of the centre portion of the hysteresis region [3]. Initially, the device has low brightness operating at $V_{s}$. It can be turned 'on' by increasing the excitation voltage to $V_{\mathrm{ON}} \sim V_{\mathrm{s}}+V_{0}$ and turned 'off' by reducing $V_{\mathrm{s}}$, at voltage $V_{0}$. The optimum value of $V_{0}$ is usually chosen so that $V_{\text {ON }}$ reaches the 'knee' point voltage in the device's B-V response curve.

From a device and even an equipment point of view, hysteresis in B-V response curve is the most important advantage of ACTFEL devices for large-area applications. In spite of the fact that the brightness of a memory-type EL, in general, is lower than that of non-memory ones [4], their advantage lies in the possibility of operating on an arbitrary number of pixels in the matrix addressing mode at the same brightness level as the one-pixel device. Thus, memory devices are potentially more suitable for large area display operation.

A pronounced hysteresis effect in the brightness vs. pulse width (B-W) response curve for memory ACTFEL devices driven near the threshold voltage has also been found and its use to address memory EL displays was suggested. Therefore, on the basis of these investigations we have inspected the dependence of the B-W characteristics on the film thickness of the $\mathrm{ZnS}: \mathrm{Mn}$ layer. The variations of the response times with respect to these parameters were also studied. The first results are reported in this paper.

## 2 EXPERIMENTAL

The studied ACTFEL devices represent the structure composed of layers of $\mathrm{SiO}_{2}(150$ nm ), $\mathrm{Y}_{2} \mathrm{O}_{3}(300 \mathrm{~nm}), \mathrm{ZnS}: \mathrm{Mn}$ (various thickness from 200 to 900 nm ), $\mathrm{Y}_{2} \mathrm{O}_{3}(300 \mathrm{~nm}), \mathrm{SiO}_{2}$ $(150 \mathrm{~nm})$ deposited onto an indium-tin-oxide (ITO) coated glass substrate.

The experimental setup used in the measurement is shown in Fig. 1. The samples were mounted in a thermal chamber, and driven by the voltage provided by the high-voltage pulse shaper. DC or AC pulses with variable durations and voltages could be generated.


Fig. 1: Experimental setup for measuring the electro-optical characteristics of TFEL devices.

All electro-optical measurements are taken by using our standard experimental setup, in which the ACTFEL device is placed in series with a resistor and a large sense capacitor. For
brightness-pulse width (B-W) measurements, a 150 Hz AC voltage with square-pulse widths ranging from $20 \mu \mathrm{~s}$ to $200 \mu \mathrm{~s}$ was applied (waveform generator Agilent 33220A in conjunction with a high-voltage operational amplifier 7265 DSP). The emitted light brightness was measured as a function of the pulse width, for a given peak-to-peak voltage, using an Ocean Optics PR-650 digital photometer. For the response-time measurements, a Hamamatsu type R928 photomultiplier tube (rise time $\sim 25 \mathrm{~ns}$ ) was used to detect the pulsedlight output. The voltage pulse and optical response were monitored on an Agilent 54621A digitizing oscilloscope and the results were plotted on a recorder [5].

## 3 RESULTS AND DISCUSSION

As an example of obtained results, the measured relations of the B-W response curves at various peak-to-peak voltages for the $\mathrm{ZnS}: \mathrm{Mn}$ film thickness of 600 nm are shown in Fig. 2. As can be seen, a pronounced hysteresis effect is observed for the device driven near the threshold voltage.

Let the brightness margin, $\Delta B$, be defined as the hysteresis width at pulse width $20 \mu \mathrm{~s}$, the observed variations of $\Delta B$ and the threshold voltage with respect to the $\mathrm{ZnS}: \mathrm{Mn}$ film thickness are shown in Fig. 3. It is noted from Fig. 3 that the hysteresis appears only if the ZnS film is thicker than 200 nm . Above it, the hysteresis width $\Delta B$ increases with the film thickness.


Fig. 2: $\quad$ The measured relation of the brightness versus pulse width $(B-W)$ at various peak-to-peak voltage of the memory EL device at excitation frequency 150 Hz .

It is also noted from Fig. 3 that the threshold voltage of these devices changes dramatically from one device to another. Within the experimental error, the threshold voltage was found to increase approximately linearly with the ZnS film thickness. This result is understandable. Experimentally, it has been proven that the excitation mechanism in $\mathrm{ZnS}: \mathrm{Mn}$ EL devices is due to the direct impact excitation of the activator ions of $\mathrm{Mn}^{2+}$ by 'hot' electrons [6]. These electron s were originally trapped at the active ( ZnS )-insulator $\left(\mathrm{Y}_{2} \mathrm{O}_{3}\right)$ interface states. At high enough applied voltages, they tunnel from the interface states into the conduction band of the active layer. They are subsequently accelerated by the high electric
field and the impacts excite the activator ions, $\mathrm{Mn}^{2+}$. Light is emitted as the ions undergo radiative decay from the excited state to the ground state [6]. As a result, the threshold voltage is related primarily to electron tunneling which is induced by the electric field ( $\mathrm{E}=\mathrm{V} / \mathrm{d}$ ) inside the layers. Therefore, the threshold voltage should increase as the thickness of the ZnS film increases.


Fig. 3: $\quad$ The observed variations of brightness margin, $\Delta B$ (curve $B M$ ) and threshold voltage $V_{p-p}$ (curve TV) with respect to the film thickness of ZnS :Mn layer.

It should also be noted from Tab. 1 that the rise-time and the decay-time are not equal. It is known that the rise-time is controlled by the crystalline properties of the $\mathrm{ZnS}: \mathrm{Mn}$ layer.

| ZnS:Mn <br> layer thickness (nm) | Device | $\mathbf{T}_{\mathbf{r}}(\boldsymbol{\mu \mathbf { s } )}$ | $\mathbf{T}_{\mathbf{d}}(\boldsymbol{\mu \mathbf { s } )}$ |
| :---: | :---: | :---: | :---: |
| 200 | $\mathrm{D}_{1}$ | 75 | 105 |
| 450 | $\mathrm{D}_{2}$ | 81 | 111 |
| 600 | $\mathrm{D}_{3}$ | 80 | 100 |
| 750 | $\mathrm{D}_{4}$ | 84 | 105 |
| 900 | $\mathrm{D}_{5}$ | 78 | 108 |

Tab. 1: $\quad$ The measured results of the rise-time $\left(T_{r}\right)$ and the decay-time ( $T_{d}$ ) for $\mathrm{ZnS}: M n E L$ devices having various thickness of the active layer

Electrons reach the excite-impact energy faster in large grained $\mathrm{ZnS}: \mathrm{Mn}$ thus decreasing the device's rise-time. The decay-time, on the other hand, is determined by the radiation decay time of luminous centers $\mathrm{Mn}^{2+}$ from their excited state. According to this picture, the rise-time should be independent of the ambient temperature, and the decay-time should not. The decay-time $T_{\mathrm{d}}$ can be written as

$$
\frac{1}{T_{\mathrm{d}}}=\frac{1}{T_{\mathrm{ir}}}+\frac{1}{T_{\mathrm{inr}}}
$$

where $T_{\mathrm{ir}}$ is the internal radiative decay-time, $T_{\mathrm{inr}}$ is the internal nonradiative decay time. The major nonradiative decay process for an excited $\mathrm{Mn}^{2+}$ ion is most likely due to energy transfer
to the 'killer' centers in the ZnS lattice [8]. These centers may be associated with impurity atoms, or with defects in the ZnS lattice (e.g. vacancies, dislocations, etc).

## 4 CONCLUSION

An experimental study of the brightness-pulse width characteristics of memory $\mathrm{ZnS}: \mathrm{Mn}$ ACTFEL devices is presented, in which memory of the device is assessed by monitoring the hysteresis characteristics. From the obtained results we can conclude two important notices:

1) The hysteresis appears only if the ZnS film is thicker than 200 nm . Above it, the hysteresis width $\Delta B$ increases with the film thickness.
2) The threshold voltage is related primarily to electron tunneling which is induced by the electric field ( $\mathrm{E}=\mathrm{V} / \mathrm{d}$ ) inside the layers. Therefore, the threshold voltage should increase as the thickness of the ZnS film increases.

For further development in the 21 st century, it is strongly expected to create new functional materials beyond a scope of conventional inorganic compounds. The targets of our ongoing research project are to create new organic-inorganic hybrid systems with new types of electronic and optical functions and to open the new frontiers of advanced applications, such as memory devices with a huge recording density and a light-emitting flat panel with high energy-conversion efficiency.

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